

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Elimination of RDk Using Tape Base Flip Chip on Flex for Die Stacking
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Application Number : 10/050507



Confirmation Number: 7687

First Named Applicant: Teck Lee

Attorney Docket Number: MTI-31607

Art Unit: 2813

Examiner: Jack SJ Chen

Search string: (4415403 or 6847105).pn

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4415403	1983-11-15	Bakewell		216	27
	2	6847105	2005-01-25	Koopmans		257	686

Signature

Examiner Name	Date